Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
SI	752	((solvent near2 free) solventless) same (thermoset or thermosetting)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:40
S2	412011	epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:51
S3	10436	(polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:42
S4	5	(((solvent near2 free) solventless) same (thermoset or thermosetting)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$) and ((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/30 15:29
S5	2790	((solvent near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/30 15:30
S6	30	((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (((solvent near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/30 15:30
S7	2892	(((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 09:07
S8	36	((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))) and ((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/30 15:47
S9	2892	(((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:33
S10	10436	(polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:53
S11	412011	epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 09:07
S12	30	((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))) and ((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:54
S13	1135	525/476.ccls. 528/27.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:32

S14	124	((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (525/476. ccls. 528/27.ccls.)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:32
S15	111	(((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane) and (525/476. ccls. 528/27.ccls.)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:32
S16	4	((((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (525/476. ccls. 528/27.ccls.)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:32
S17	33803	(((solvent volatile) near2 free) solventless)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:33
S18	11	((((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (525/476. ccls. 528/27.ccls.)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:33
S19	23568	(hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:54
S20	466	((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$) and ((((solvent volatile) near2 free) solventless))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:55
S21	63	(((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$) and ((((solvent volatile) near2 free) solventless))) and ((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:57
S22	3168	((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:57
S23	146	(((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 10:57
S24	35	((((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless))) and ((((solvent volatile) near2 free) solventless)) and ((epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 11:02
S25	111	((((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless))) not (((((hydrol\$8 polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)) and ((((solvent volatile) near2 free) solventless))) and ((((solvent volatile) near2 free) solventless)) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$)))))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/10/31 11:02

S26	12189	428/413.ccls. 428/414.ccls. 428/446.ccls. 428/447.ccls. 428/448.ccls. 428/901.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/11/03 09:31
S27	30	((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))) and ((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/11/03 09:32
S28	2	(428/413.ccls. 428/414.ccls. 428/446.ccls. 428/447.ccls. 428/448.ccls. 428/901.ccls.) and ((((solvent volatile) near2 free) solventless) same (thermoset or thermosetting or (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))) and ((polycondensat\$5 condensat\$5) same (silane alkoxysilane organosilane oxysilane trialkoxysilane trimethoxysilane triethoxysilane)) and (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/11/03 09:32
S29	6	"5623026"	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2003/11/03 11:01
S30	35842	((solvent volatile) near2 free) solventless	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:55
S31	141615	silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$triethoxysilane	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:58
S32	374305	condensat\$5 polycondensat\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:58
S33	438071	epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:58
S34	1386	(silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$triethoxysilane) same (condensat\$5 polycondensat\$5) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 09:59
S35	70	(((solvent volatile) near2 free) solventless) and ((silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$triethoxysilane) same (condensat\$5 polycondensat\$5) same (epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR .	ON	2004/06/17 10:01
S36	53	((silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$triethoxysilane \$triethoxys	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 10:41
S37	46	(((silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$trimethoxysilane \$triethoxysilane \$triethoxysilane \$triethoxysilane \$triethoxysilane \$triethoxysilane \$triethoxysilane adj coat\$5 (powder adj coat\$5))) and (powdercoat powdercoat\$5 (powder adj coat) (powder adj coat\$5))) not ((((solvent volatile) near2 free) solventless) and ((silane organosilane oxysilane alkoxysilane trialkoxysilane trimethoxysilane triethoxysilane \$trimethoxysilane \$trimethoxysilane \$triethoxysilane \$triethoxy	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/06/17 10:42

S40	913514	((solvent water alcohol byproduct (by adj product)) near3 (free remov\$5 evaporat\$6 distill\$6)) solventless	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ОИ	2005/01/20 11:03
S44	156777	(silane alkoxysilane organosilane oxysilane \$trialkoxysilane \$trimethoxysilane \$triethoxysilane \$tripropoxysilane \$tributoxysilane \$tryalkoxysilane \$trymethoxysilane \$tryethoxysilane \$trypropoxysilane \$trybutoxysilane)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:19
S45	11002	(polycondensat\$5 condensat\$5) with \$44	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:30
S46	4708	(react reaction reacting reacted) with water with S44	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:30
S47	421046	silicone polysiloxane polyorganosiloxane polydiorganosiloxane organopolysiloxane organosiloxane diorganopolysiloxane siloxane organosilicone	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:50
S48	492312	epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$ glycidylether\$ \$glycidylether	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:58
S49	13074	(S48 same (S45 S46 S47)) and S44	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 10:59
S50	6190	S49 and S40	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:00
S51	1263	S50 and (S45 S46)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:01
S52	182	S51 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:34
S53	49271	(solvent near3 free) solventless	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:25

		L		1 ==	T _ : .	T = = = = = = = = = = = = = = = = = = =
S54	29	S52 and S53	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:09
S55	1221	S50 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:04
S56	161	S55 and S53	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:05
S57	156778	(silane alkoxysilane organosilane oxysilane \$trialkoxysilane \$trimethoxysilane \$triethoxysilane \$trynethoxysilane \$trynethoxysilane \$trynethoxysilane \$trypthoxysilane \$trypthoxysilane \$trypthoxysilane \$trypthoxysilane \$methoxydiethoxysilane \$diethoxymethoxysilane \$ethoxydimethoxysilane \$dimethoxyethoxysilane)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:29
\$58	11002	(polycondensat\$5 condensat\$5) with S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:30
S59	4707	(react reaction reacting reacted) with water with S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:31
S60	14004	S58 S59	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:32
S61	2338	S53 with (thermoset thermosetting thermosett S48)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:36
S62	31729	powder with (thermoset thermosetting thermosett S48)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:50
S63	33744	S61 S62	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:50
S64	207	S63 and S60 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:26

S65	30	S64 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ОИ	2005/01/20 11:52
S66	5660	(powder adj2 (coating composition)) with (thermoset thermosetting thermosett S48)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:50
S67	7920	S61 S66	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:50
S68	68	S67 and S60 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:56
S69	3	S68 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:56
S70	29	S61 and S60 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:02
S71	5	"l333" and (semiconductor (semi adj conductor)) .	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 11:57
S72	2	S70 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:07
S73	23623	525/474.ccls. 525/476.ccls. 525/523.ccls. 438/106.ccls. 438/118.ccls. 438/127.ccls. 428/413.ccls. 428/414.ccls. 428/415.ccls. 428/416.ccls. 428/417.ccls. 428/418.ccls. 428/447.ccls. 428/448.ccls. 428/450.ccls. 428/901.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:06
S74	654	S73 and S60 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:07
S75	81	S74 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:27

					_	
S76	6	S74 and (semiconductor (semi adj conductor)) and S53	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:07
S77	53985	((solvent volatile volatiles "voc") near3 free) solventless	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:26
S78	362	S77 and S60 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:26
S79	46	S78 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:37
S80	21686	S48 same S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:30
S81	31	S79 and S80	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:30
S82	4122	S77 same (thermoset thermosetting thermosett S48)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/20 13:36
S83	58	S78 and S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S84	5	S83 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 09:05
S85	504207	epox\$5 diepox\$5 polyepox\$5 diglycidyl\$ polyglycidyl\$ glycidylether\$\$glycidylether\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S86	161357	(silane alkoxysilane organosilane oxysilane \$trialkoxysilane \$trimethoxysilane \$triethoxysilane \$trymethoxysilane \$trymethoxysilane \$tryethoxysilane \$tryethoxysilane \$tryethoxysilane \$tryethoxysilane \$tryethoxysilane \$tryethoxysilane \$methoxydiethoxysilane \$diethoxymethoxysilane \$ethoxydimethoxysilane \$dimethoxyethoxysilane)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52

			-,			
S87	11310	(polycondensat\$5 condensat\$5) with S86	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S88	4820	(react reaction reacting reacted) with water with S86	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S89	14382	S87 S88	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S90	55089	((solvent volatile volatiles "voc") near3 free) solventless	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S91	372	S90 and S89 and S85	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S92	4191	S90 same (thermoset thermosetting thermosett S85)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S93	59	S91 and S92	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 08:52
S94	59	S93	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 09:03
S95	5	S93 and (semiconductor (semi adj conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 09:05
S96	5	S95	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/12 09:05